

Application Data Sheet

APPLICATION INFORMATION

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?:

Computer Readable From (CRF)?:: No

Number of Copies of CRF::

Title:: METHOD OF WIRING SEMICONDUCTOR
INTEGRATED CIRCUIT, SEMICONDUCTOR
INTEGRATED CIRCUIT, AND COMPUTER
PRODUCT

Attorney Docket Number:: 401558

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure::

Total Drawing Sheets:: 11

Small Entity?: No

Latin Name::

Variety denomination name::

Petition Included?: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?: No

10073326-021302

1007328-021301

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Takao
Middle Name::
Family Name:: HASEGAWA
Name Suffix::
City of Residence:: Tokyo
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Mitsubishi Denki Kabushiki Kaisha,
2-3, Marunouchi 2-chome, Chiyoda-ku
City of mailing address:: Tokyo
State or Province of mailing address::
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 100-8310
Inventor Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name::
Middle Name::
Family Name::
Name Suffix::
City of Residence::
State or Prov. of Residence::
Country of Residence:: US
Street of mailing address::
City of mailing address::
State or Province of mailing address::
Country of mailing address:: US
Postal or Zip Code of mailing address::

THE BUREAU

REPRESENTATIVE INFORMATION

Representative Designation::	Registration Number::	Representative Name::
------------------------------	-----------------------	-----------------------

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2001-215793	07/16/01	Yes

ASSIGNEE INFORMATION

Assignee name::	Mitsubishi Denki Kabushiki Kaisha
Street of mailing address::	2-3, Marunouchi 2-chome, Chiyoda-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	100-8310